

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE



Wire Application of
Viswanathan, et al. : Group Art Unit: 2818
Serial No.: 10/039,800 : Examiner: Mai Huong C. Tran
Filed: January 4, 2002 :
Title: Wire Bond-Less Electronic Component For Use With External Circuit And Method
Of Manufacture

INFORMATION DISCLOSURE STATEMENT

Mail Stop DD
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Attached hereto is a completed Form PTO-1449 listing patents, publications, applications, or other information, with copies of each such item enclosed herewith. It is requested that the cited patents, publications, applications, or other information be made of record in the examination of this application. No representation is made that a search has been performed. No admission is made that the information cited in this statement is, or is considered to be, material to the patentability of the subject patent application.

Pursuant to 37 C.F.R. §1.97(c), this information disclosure statement is being filed before the mailing date of any of: (1) a final action under § 1.113; (2) a notice of allowance under § 1.311, or (3) an action that otherwise closes prosecution in the application. As required by 37 C.F.R. §1.97(c)(1), Applicant hereby makes the following statement under 37 C.F.R. §1.97(e): each item of information contained in the information disclosure statement was first cited in any communication from a foreign patent office in a counterpart foreign application not more than

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Information Disclosure Statement

three months prior to the filing of the information disclosure statement. Accordingly, no fee is required. The commissioner is, however, authorized to charge any fee deficiency required by this paper, or credit any overpayment, to Deposit Account No. 02-4467.

Respectfully submitted,

Dated: Aug. 28, 2003

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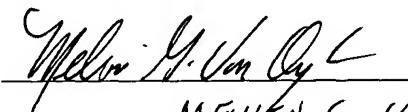
Title: Wire Bond-Less Electronic Component For Use With External Circuit And
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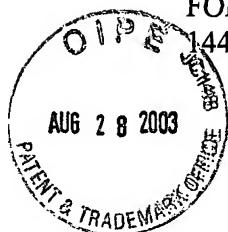
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	125994		10/039,800	
	APPLICANT Viswanathan, et al.			
	FILING DATE 01/04/02			GROUP 2818

U.S. PATENT DOCUMENTS

EXAMINER INITIAL	DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
	5,998,875	12/7/99	Bodö, et al.			
	5,023,624	6/11/91	Heckaman, et al.			

FOREIGN PATENT DOCUMENTS

	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION
						YES NO
	11031757	02/02/99	Japan			yes
	2001053197	02/23/01	Japan			yes
	EP1079433	02/28/01	EP			N/A

OTHER DOCUMENTS (Including Author, Title, Date Pertinent Pages, Etc.)

EXAMINER**DATE
CONSIDERED**

EXAMINER: Initial citation considered. Draw line through citation if not in the conformance and not considered. Include copy of this form with next communication to applicant.

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